SiT9025

AEC-Q100, 1 to 150 MHz EMI Reduction Oscillator



Features

- Spread spectrum for EMI reduction
 - Wide spread % option
 - Center spread: from ±0.125% to ±2%, ±0.125% step size
 - Down spread: -0.25% to -4% with -0.25% step size
 - Spread profile option: Triangular, Hershey-kiss, Random
- Programmable rise/fall time for EMI reduction: 8 options, 0.25 to 40 ns
- AEC-Q100 with extended temperature range (-55°C to 125°C)
- Any frequency between 1 MHz and 150 MHz accurate to 6 decimal places
- 100% pin-to-pin drop-in replacement to guartz-based XO's
- Excellent total frequency stability as low as ±25 ppm
 - Contact SiTime for ±20 ppm option
- Low power consumption of 6.6 mA typical at 1.8 V
- Pin1 modes: Standby, output enable, or spread disable
- LVCMOS output
- Industry-standard packages
 - QFN: 2.0 x 1.6 mm², 2.5 x 2.0 mm², 3.2 x 2.5 mm²
- RoHS and REACH compliant, Pb-free, Halogen-free and Antimony-free

Applications

- Rear/Surround view camera
- Driver monitor
- ADAS ECU/CPU
- High speed serial link









Electrical Specifications

Table 1. Electrical Characteristics

All Min and Max limits are specified over temperature and rated operating voltage with 15 pF output load unless otherwise stated. Typical values are at 25°C and 3.3 V supply voltage.

Parameters	Symbol	Min.	Тур.	Max.	Unit	Condition		
				Freque	ency Range			
Output Frequency Range	f	1	-	150	MHz			
			Fr	equency S	tability and	I Aging		
Frequency Stability ^[1]	F_stab	-25	-	+25	ppm	Inclusive of initial tolerance at 25°C, 1st year aging at 25°C, and variations over operating temperature, rated power supply voltage.		
		-50	-	+50	ppm	Spread = Off.		
Operating Temperature Range								
Operating Temperature	T_use	-40	-	+85	°C	AEC-Q100 Grade 3		
Range		-40	-	+105	°C	AEC-Q100 Grade 2		
		-40	-	+125	°C	AEC-Q100 Grade 1		
		-55	-	+125	°C	Extended cold AEC-Q100 Grade 1		
			Supply \	Voltage and	d Current C	Consumption		
Supply Voltage	Vdd	1.62	1.8	1.98	V			
		2.25	2.5	2.75	V			
		2.52	2.8	3.08	V			
		2.7	3.0	3.3	V			
		2.97	3.3	3.63	V			
		2.25	-	3.63	V			
Current Consumption	ldd	-	7.9	9.5	mA	No load condition, f = 148.5 MHz, Vdd = 2.5 V to 3.3 V		
		_	6.6	8.0	mA	No load condition, f = 148.5 MHz, Vdd = 1.8 V		
OE Disable Current	I_OD	-	5.3	6.5	mA	f = 148.5 MHz, Vdd = 2.5 V to 3.3 V, OE = GND, Output in high-Z state		
		_	5.0	6.0	mA	f = 148.5 MHz, Vdd = 1.8 V, OE = GND, Output in high-Z state		
Standby Current	I_std	-	2.6	9.0	μΑ	ST = GND, Vdd = 2.5 V to 3.3 V, Output is weakly pulled down		
		-	0.6	5.0	μА	ST = GND, Vdd = 1.8 V, Output is weakly pulled down		



Table 1. Electrical Characteristics (continued)

Parameters	Symbol	Min.	Тур.	Max.	Unit	Condition
			LV	CMOS Out	put Charac	teristics
Duty Cycle	DC	45	-	55	%	f = 1 to 137 MHz
		43	-	57	%	f = 137.000001 to 150 MHz
Rise/Fall Time	Tr, Tf	-	1.2	2.0	ns	20% - 80%, default derive strength
Output High Voltage	VOH	90%	-	-	Vdd	IOH = -4 mA (Vdd = 3.0 V or 3.3 V) IOH = -3 mA (Vdd = 2.8 V and Vdd = 2.5 V) IOH = -2 mA (Vdd = 1.8 V)
Output Low Voltage	VOL	1	-	10%	Vdd	IOL = 4 mA (Vdd = 3.0 V or 3.3 V) IOL = 3 mA (Vdd = 2.8 V and Vdd = 2.5 V) IOL = 2 mA (Vdd = 1.8 V)
				Input CI	haracterist	ics
Input High Voltage	VIH	70%	-	_	Vdd	Pin 1, OE or ST
Input Low Voltage	VIL	-	-	30%	Vdd	Pin 1, OE or ST
Input Leakage Current	IL	-	-2.3	-	μΑ	Pin1, ST logic low
		-	2.8	-	μA	Pin1, ST logic high
		_	-24.6	_	μΑ	Pin1, OE / SD logic low
		-	3.2	-	μΑ	Pin1, OE / SD logic high
				Startup and	d Resume 1	Fiming
Startup Time	T_start	1	1	10	ms	Measured from the time Vdd reaches its rated minimum value
Enable/Disable Time	T_oe	-	_	215	ns	f = 148.5 MHz. For other frequencies, T_oe = 100 ns + 3 * cycles
Resume Time	T_resume	-	_	10	ms	Measured from the time ST pin crosses 50% threshold
Spread Enable Time	T_sde	ı	ı	4	μS	Measured from the time SD pin crosses 50% threshold
Spread Disable Time	T_sdde	-	-	55	μS	Measured from the time SD pin crosses 50% threshold
					Jitter	
Cycle-to-cycle jitter	T_ccj	_	10.5	_	ps	f = 148.5 MHz, Vdd = 2.5 to 3.3 V, Spread = ON (or OFF)
		1	10.8	_	ps	f = 148.5 MHz, Vdd = 1.8 V, Spread = ON (or OFF)

Note:

1. Contact SiTime for ±20 ppm option.

Table 2. Spread Spectrum %[3]

Ordering Code	Center Spread (%)	Down Spread (%)
A	±0.125	-0.25
В	±0.250	-0.50
С	±0.390	-0.78
D	±0.515	-1.04
Е	±0.640	-1.29
F	±0.765	-1.55
G	±0.905	-1.84
Н	±1.030	-2.10
1	±1.155	-2.36
J	±1.280	-2.62
K	±1.420	-2.91
L	±1.545	-3.18
М	±1.670	-3.45
N	±1.795	-3.71
0	±1.935	-4.01
Р	±2.060	-4.28

Table 3. Spread Profile^[2,3]

Spread Profile
Triangular
Hershey-kiss
Random

Notes:

- 2. In both Triangular and Hershey-kiss profiles, modulation rate is employed with a frequency of \sim 31.25 kHz. In random profile, modulation rate is \sim 8.6 kHz.
- 3. The random profile supports up to ±1.030% center spread or -2.10% down spread (ordering codes A through H).



Table 4. Pin Description

Pin	Symbol		Functionality
1	OE/ST/ NC/SD	Output Enable	H ^[4] : specified frequency output L: output is high impedance. Only output driver is disabled.
		Standby	H ^[4] : specified frequency output L: output is low (week pull down). Device goes to sleep mode. Supply current reduced to I_std.
		No Connect	Pin1 has no function (Any voltage between 0 and Vdd or Open)
		Spread Disable	H: Spread = ON L: Spread = OFF
2	GND	Power	Electrical ground
3	OUT	Output	Oscillator output
4	VDD	Power	Power supply voltage ^[5]

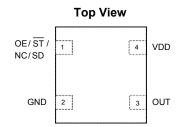


Figure 1. Pin Assignments

Notes:

- 4. In OE or ST mode, a pull-up resistor of 10 kΩ or less is recommended if pin 1 is not externally driven. If pin 1 needs to be left floating, use the NC option.
- 5. A capacitor of value $0.1~\mu F$ or higher between Vdd and GND is required.

Table 5. Absolute Maximum Limits

Attempted operation outside the absolute maximum ratings may cause permanent damage to the part. Actual performance of the IC is only guaranteed within the operational specifications, not at absolute maximum ratings.

Parameter	Min.	Max.	Unit
Storage Temperature	-65	150	°C
Vdd	-0.5	4	V
Electrostatic Discharge	=	2000	V
Soldering Temperature (follow standard Pb free soldering guidelines)	=	260	°C
Junction Temperature ^[6]	_	150	°C

Note:

6. Exceeding this temperature for extended period of time may damage the device.

Table 6. Maximum Operating Junction Temperature[7]

Max Operating Temperature (ambient)	Maximum Operating Junction Temperature
85°C	95°C
105°C	115°C
125°C	135°C

Note:

7. Datasheet specifications are not guaranteed if junction temperature exceeds the maximum operating junction temperature.

Table 7. Environmental Compliance

Parameter	Condition/Test Method		
Mechanical Shock	MIL-STD-883F, Method 2002		
Mechanical Vibration	MIL-STD-883F, Method 2007		
Temperature Cycle	JESD22, Method A104		
Solderability	MIL-STD-883F, Method 2003		
Moisture Sensitivity Level	MSL1 @ 260°C		



Timing Diagrams

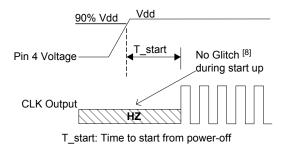
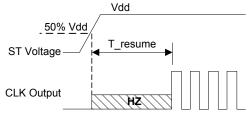
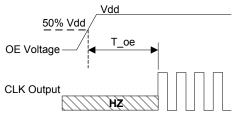


Figure 2. Startup Timing



T_resume: Time to resume from ST

Figure 3. Standby Resume Timing (ST Mode Only)



T_oe: Time to re-enable the clock output

Figure 4. OE Enable Timing (OE Mode Only)

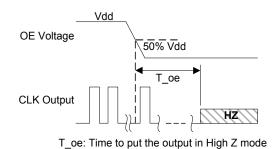


Figure 5. OE Disable Timing (OE Mode Only)

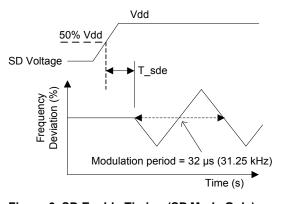


Figure 6. SD Enable Timing (SD Mode Only)

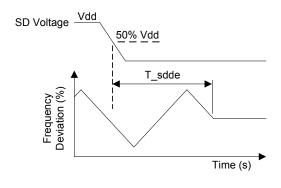


Figure 7. SD Diable Timing (SD Mode Only)

Note:

8. SiT9025 has "no runt" pulses and "no glitch" output during startup or resume.



Performance Plots

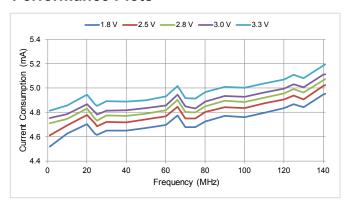


Figure 8. OE Disable Current vs Frequency

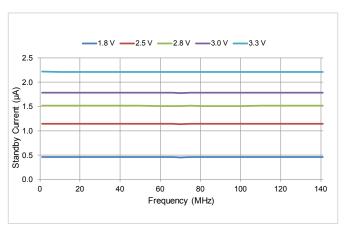


Figure 10. Standby Current vs Frequency

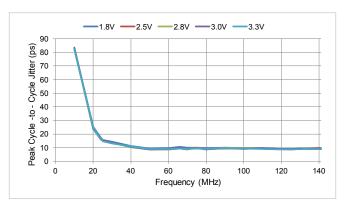


Figure 12. Cycle-to-cycle Jitter vs Frequency (Spread profile: Triangular, Spread type: center, Spread percentage: ±2.060%)

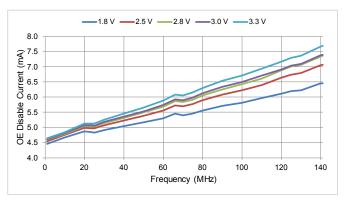


Figure 9. Current Consumption vs Frequency

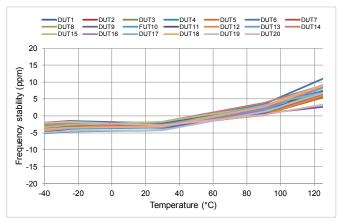


Figure 11. Frequency vs Temperature



Rise/Fall Time (20% to 80%) vs CLOAD Tables

Table 8. Vdd = 1.8 V Rise/Fall Times for Specific CLOAD

Rise/Fall Time Typ (ns)								
Drive Strength \ C _{LOAD}	ive Strength \ C _{LOAD} 5 pF 15 pF 30 pF 45 pF 60 p							
L	6.16	11.61	22.00	31.27	39.91			
Α	3.19	6.35	11.00	16.01	21.52			
R	2.11	4.31	7.65	10.77	14.47			
В	1.65	3.23	5.79	8.18	11.08			
T	0.93	1.91	3.32	4.66	6.48			
E	0.78	1.66	2.94	4.09	5.74			
U	0.70	1.48	2.64	3.68	5.09			
F or "-": default	0.65	1.30	2.40	3.35	4.56			

Table 10. Vdd = 2.8 V Rise/Fall Times for Specific CLOAD

				-				
Rise/Fall Time Typ (ns)								
Drive Strength \ C _{LOAD}	rive Strength \ C _{LOAD} 5 pF 15 pF 30 pF 45 pF 60 pF							
L	3.77	7.54	12.28	19.57	25.27			
Α	1.94	3.90	7.03	10.24	13.34			
R	1.29	2.57	4.72	7.01	9.06			
В	0.97	2.00	3.54	5.43	6.93			
Т	0.55	1.12	2.08	3.22	4.08			
E or "-": default	0.44	1.00	1.83	2.82	3.67			
U	0.34	0.88	1.64	2.52	3.30			
F	0.29	0.81	1.48	2.29	2.99			

Table 12. Vdd = 3.3 V Rise/Fall Times for Specific CLOAD

Rise/Fall Time Typ (ns)									
Drive Strength \ C _{LOAD}	Orive Strength \ C _{LOAD} 5 pF 15 pF 30 pF 45 pF 60 pF								
L	3.39	6.88	11.63	17.56	23.59				
Α	1.74	3.50	6.38	8.98	12.19				
R	1.16	2.33	4.29	6.04	8.34				
В	0.81	1.82	3.22	4.52	6.33				
T or "-": default	0.46	1.00	1.86	2.60	3.84				
E	0.33	0.87	1.64	2.30	3.35				
U	0.28	0.79	1.46	2.05	2.93				
F	0.25	0.72	1.31	1.83	2.61				

Table 9. Vdd = 2.5 V Rise/Fall Times for Specific C_{LOAD}

Rise/Fall Time Typ (ns)								
Drive Strength \ C _{LOAD}	rive Strength \ C _{LOAD} 5 pF 15 pF 30 pF 45 pF 60 pF							
L	4.13	8.25	12.82	21.45	27.79			
Α	2.11	4.27	7.64	11.20	14.49			
R	1.45	2.81	5.16	7.65	9.88			
В	1.09	2.20	3.88	5.86	7.57			
Т	0.62	1.28	2.27	3.51	4.45			
E or "-": default	0.54	1.00	2.01	3.10	4.01			
U	0.43	0.96	1.81	2.79	3.65			
F	0.34	0.88	1.64	2.54	3.32			

Table 11. Vdd = 3.0 V Rise/Fall Times for Specific C_{LOAD}

Rise/Fall Time Typ (ns)					
Drive Strength \ C _{LOAD}	5 pF	15 pF	30 pF	45 pF	60 pF
L	3.60	7.21	11.97	18.74	24.30
Α	1.84	3.71	6.72	9.86	12.68
R	1.22	2.46	4.54	6.76	8.62
В	0.89	1.92	3.39	5.20	6.64
T or "-": default	0.51	1.00	1.97	3.07	3.90
E	0.38	0.92	1.72	2.71	3.51
U	0.30	0.83	1.55	2.40	3.13
F	0.27	0.76	1.39	2.16	2.85



Programmable Drive Strength

The SiT9025 includes a programmable drive strength feature to provide a simple, flexible tool to optimize the clock rise/fall time for specific applications. Benefits from the programmable drive strength feature are:

- Improves system radiated electromagnetic interference (EMI) by slowing down the clock rise/fall time.
- Improves the downstream clock receiver's (RX) jitter by decreasing (speeding up) the clock rise/fall time.
- Ability to drive large capacitive loads while maintaining full swing with sharp edge rates.

For more detailed information about rise/fall time control and drive strength selection, see the SiTime Application Notes section.

EMI Reduction by Slowing Rise/Fall Time

Figure 13 shows the harmonic power reduction as the rise/fall times are increased (slowed down). The rise/fall times are expressed as a ratio of the clock period. For the ratio of 0.05, the signal is very close to a square wave. For the ratio of 0.45, the rise/fall times are very close to near-triangular waveform. These results, for example, show that the 11th clock harmonic can be reduced by 35 dB if the rise/fall edge is increased from 5% of the period to 45% of the period.

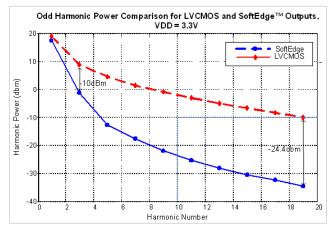


Figure 13. Harmonic EMI reduction as a function of slower rise/fall time

Jitter Reduction with Faster Rise/Fall Time

Power supply noise can be a source of jitter for the downstream chipset. One way to reduce this jitter is to increase rise/fall time (edge rate) of the input clock. Some chipsets would require faster rise/fall time in order to reduce their sensitivity to this type of jitter. The SiT9025 provides up to 3 additional high drive strength settings for very fast rise/fall time. Refer to the Rise/Fall Time Tables to determine the proper drive strength.

High Output Load Capability

The rise/fall time of the input clock varies as a function of the actual capacitive load the clock drives. At any given drive strength, the rise/fall time becomes slower as the output load increases. As an example, for a 3.3 V SiT9025 device with default drive strength setting, the typical rise/fall time is 1.1 ns for 15 pF output load. The typical rise/fall time slows down to 2.9 ns when the output load increases to 45 pF. One can choose to speed up the rise/fall time to 1.9 ns by then increasing the drive strength setting on the SiT9025.

The SiT9025 can support up to 60 pF or higher in maximum capacitive loads with up to 3 additional drive strength settings. Refer to the Rise/Tall Time Tables to determine the proper drive strength for the desired combination of output load vs. rise/fall time.

SiT9025 Drive Strength Selection

Tables 8 through 12 define the rise/fall time for a given capacitive load and supply voltage.

- 1. Select the table that matches the SiT9025 nominal supply voltage (1.8 V, 2.5 V, 2.8 V, 3.3 V).
- 2. Select the capacitive load column that matches the application requirement (15 pF to 60 pF)
- 3. Under the capacitive load column, select the desired rise/fall times.
- The left-most column represents the part number code for the corresponding drive strength.
- **5.** Add the drive strength code to the part number for ordering purposes.

Calculating Maximum Frequency

Based on the rise and fall time data given in Tables 8 through 12, the maximum frequency the oscillator can operate with guaranteed full swing of the output voltage over temperature as follows:

Max Frequency =
$$\frac{1}{5 \times \text{Trf}_{20/80}}$$

where Trf_20/80 is the typical value for 20%-80% rise/fall time.

Example 1

Calculate f_{MAX} for the following condition:

- Vdd = 1.8 V (Table 8)
- Capacitive Load: 30 pF
- Desired Tr/f time = 3 ns (rise/fall time part number code = E)

Part number for the above example:

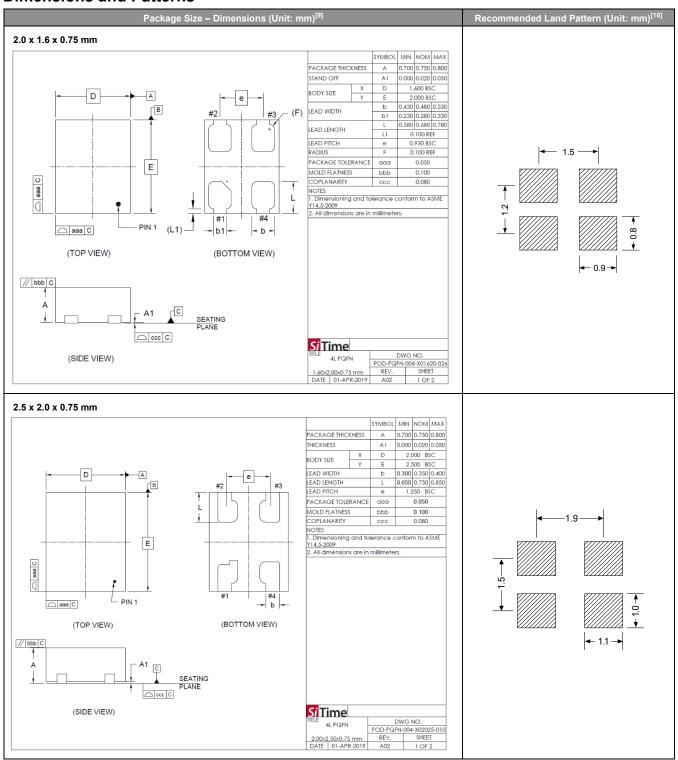
Drive strength code is inserted here. Default setting is "-"

Supplied Voltage

The supplied voltage must always stay within the range from minimum to maximum limits of rated operating voltage to guarantee specification performance. The supply voltage must drop below 0.6 V for the device to reset.

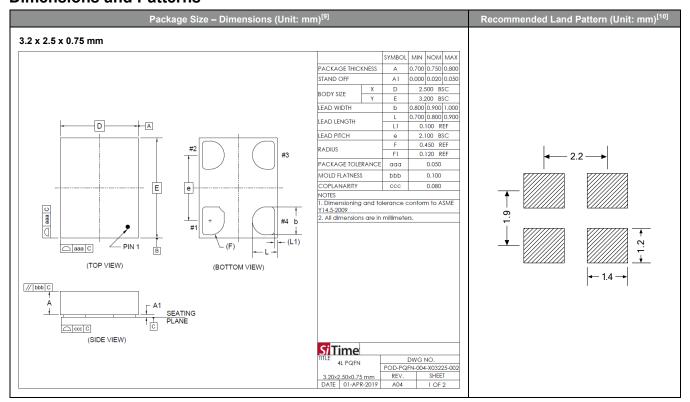


Dimensions and Patterns





Dimensions and Patterns



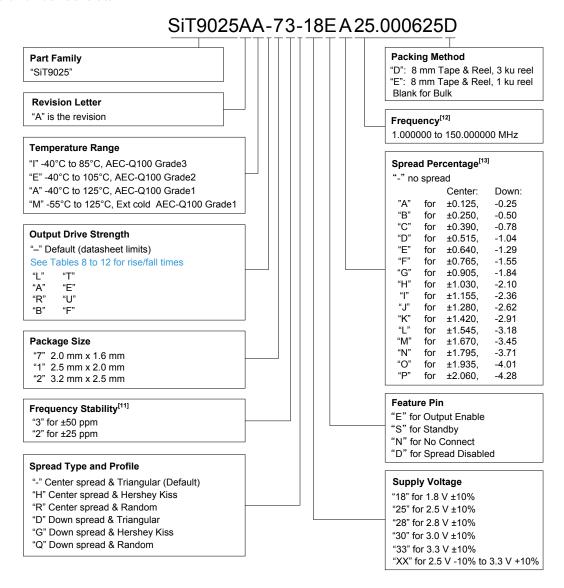
Notes

- 9. Top marking: Y denotes manufacturing origin and XXXX denotes manufacturing lot number. The value of "Y" will depend on the assembly location of the device.
- 10. A capacitor of value 0.1 μF or higher between Vdd and GND is required.



Ordering Information

The following part number guide is for reference only. To customize and build an exact part number, use the SiTime Part Number Generator.



Note:

- 11. Contact SiTime for ±20 ppm option.
- 12. Refer to the Supported Frequencies tables below.
- 13. The random profile supports up to ±1.030% center spread or -2.10% down spread (ordering codes A through H).



Supported Frequencies Tables

Table 13. Supported Frequencies (-40 to +85°C, Center spread)

Spread Percentage (%)	Supported Frequencies (MHz)		
Center spread	Min.	Max.	
"A": ±0.125 "B": ±0.250 "C": ±0.390 "D": ±0.515 "E": ±0.640 "F": ±0.765 "G": ±0.905 "H": ±1.030 "I": ±1.155 "J": ±1.280 "K": ±1.420 "L": ±1.545 "M": ±1.670 "N": ±1.795 "O": ±1.935 "P": ±2.060	1.000000	150.00000	

Table 15. Supported Frequencies (-40 to +105°C or -40 to +125°C, Center spread)

Spread Percentage (%)	Supported Frequencies (MHz)		
Center spread	Min.	Max.	
"A": ±0.125			
"B": ±0.250			
"C": ±0.390			
"D": ±0.515			
"E": ±0.640	1.000000	150.000000	
"F": ±0.765	1.000000	100.00000	
"G": ±0.905			
"H": ±1.030			
"l": ±1.155			
"J": ±1.280			
"K": ±1.420	1.000000	149.900000	
WL W. A. E.A.E.	1.000000	120.100000	
"L": ±1.545	120.700000	149.800000	
	1.000000	119.900000	
"M": ±1.670	124.500000	149.600000	
	1.000000	100.100000	
"N": ±1.795	102.700000	119.600000	
	128.400000	149.300000	
	1.000000	85.800000	
"O". 11 025	86.100000	100.100000	
"O": ±1.935	103.400000	119.400000	
	129.200000	149.100000	
	1.000000	74.500000	
	75.800000	85.400000	
"P": ±2.060	88.500000	99.300000	
	106.200000	119.200000	
	132.700000	148.900000	

Table 14. Supported Frequencies (-40 to +85°C, Down spread)

Spread Percentage (%)	Supported Frequencies (MHz)		
Down spread	Min.	Max.	
"A": -0.25			
"B": -0.50			
"C": -0.78			
"D": -1.04			
"E": -1.29			
"F": -1.55			
"G": -1.84			
"H": -2.10	4.000000	450,00000	
"I": -2.36	1.000000	150.00000	
"J": -2.62			
"K": -2.91			
"L": -3.18			
"M": -3.45			
"N": -3.71			
"O": -4.01			
"P": -4.28			

Table 16. Supported Frequencies (-40 to +105°C or -40 to +125°C, Down spread)

(
Spread Percentage (%)	Supported Frequencies (MHz)		
Down spread	Min.	Max.	
"A": -0.25			
"B": -0.50			
"C": -0.78			
"D": -1.04			
"E": -1.29			
"F": -1.55			
"G": -1.84	1.000000	150.000000	
"H": -2.10			
"I": -2.36			
"J": -2.62			
"K": -2.91			
"L": -3.18			
"M": -3.45			
"N": -3.71	1.000000	120.100000	
14 : 0.71	123.200000	150.000000	
	1.000000	100.100000	
"O": -4.01	101.600000	120.100000	
	127.000000	150.000000	
	1.000000	85.800000	
"P": -4.28	87.400000	100.100000	
	102.400000	102.900000	
	104.800000	120.100000	
	128.100000	128.600000	
	131.100000	150.000000	



Table 17. Supported Frequencies (-55 to +125°C, Center spread)

Spread Percentage (%)	Supported Frequencies (MHz)		
Center spread	Min.	Max.	
"A": ±0.125			
"B": ±0.250		150.000000	
"C": ±0.390			
"D": ±0.515			
"E": ±0.640	1.000000		
"F": ±0.765			
"G": ±0.905			
"H": ±1.030			
"I": ±1.155			
"J": ±1.280			
"K": ±1.420	1.000000	120.100000	
	120.900000	149.900000	
"L": ±1.545	1.000000	120.100000	
	124.700000	149.800000	
	1.000000	100.100000	
"M": ±1.670	102.900000	119.800000	
	128.600000	149.600000	
	1.000000	85.800000	
"N": ±1.795	86.300000	100.100000	
N : ±1.795	103.500000	119.600000	
	129.400000	149.300000	
	1.000000	74.600000	
	75.900000	85.600000	
"O": ±1.935	88.6000000	99.500000	
	106.300000	119.400000	
	132.900000	149.100000	
	1.000000	60.100000	
	60.200000	66.500000	
	67.700000	74.500000	
"P": ±2.060	77.400000	85.400000	
	90.300000	99.300000	
	108.400000	119.100000	
	135.500000	148.900000	

Table 18. Supported Frequencies (-55 to +125°C, Down spread)

Spread Percentage (%)	Supported Frequencies (MHz)		
Down spread	Min.	Max.	
"A": -0.25 "B": -0.50 "C": -0.78 "D": -1.04 "E": -1.29 "F": -1.55 "G": -1.84 "H": -2.10	1.000000	150.000000	
"l": -2.36 "J": -2.36 "J": -2.62 "K": -2.91 "L": -3.18			
"M": -3.45	1.000000	120.100000	
	123.400000	150.000000	
	1.000000	100.100000	
"N": -3.71	101.800000	120.100000	
	127.300000	150.000000	
	1.000000	85.800000	
	87.500000	100.100000	
	102.600000	102.800000	
"O": -4.01	105.000000	120.100000	
	128.200000	128.500000	
	131.300000	150.000000	
"P": -4.28	1.000000	75.100000	
	75.600000	85.800000	
	88.200000	100.100000	
	105.800000	120.100000	
	132.300000	150.000000	
	•		



Table 19. Additional information

Document	Description	Download Link	
Manufacturing Notes	Tape & Reel dimension, reflow profile and other manufacturing related info	http://www.sitime.com/manufacturing-notes	
Qualification Reports	RoHS report, reliability reports, composition reports	http://www.sitime.com/support/quality-and-reliability	
Termination Techniques	Termination design recommendations	http://www.sitime.com/support/application-notes	
Layout Techniques	Layout recommendations	http://www.sitime.com/support/application-notes	

Table 20. Revision history

Version	Release Date	Change Summary
1.0	9-Jun-2020	Final release Formatting updates
1.01	9-Sep-2020	Supply voltage information update Added ±25 ppm frequency stability Figure 8 and 9 captions fix Changed date format in rev table to d/month/yyyy



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